





### SURFACE MOUNT FAST SWITCHING DIODE

### **Features**

- Fast Switching Speed: t<sub>rr</sub> ≤ 4.0ns
- Low Leakage Current: I<sub>R</sub> ≤ 25nA
- Low Capacitance: C<sub>T</sub> ≤ 4pF
- Flat Lead for High Thermal Efficiency
- Small Surface Mount Package
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD323F
- Case Material: Molded Plastic, "Green Molding Compound".
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper Alloy leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.007 grams (approximate)

SOD323F



Top View

### Ordering Information (Note 3)

Part Number	Qualification	Case	Packaging
1N4448WSF-7	Commercial	SOD323F	3000/Tape & Reel
1N4448WSFQ-7	Automotive	SOD323F	3000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

### **Marking Information**



TK = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	2011		2012	2013		2014	2015		2016	2017		2018
Code	Y		Z	Α		В	С		D	Е		F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

1N4448WSF Document number: DS35380 Rev. 3 - 2 1 of 4



# 

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> 75 V <sub>R</sub>		V	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current		I <sub>FM</sub>	500	mA
Average Rectified Output Current		Io	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	4 0.5	A

### **Thermal Characteristics**

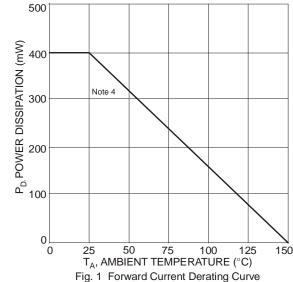
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P <sub>D</sub>	400	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	313	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

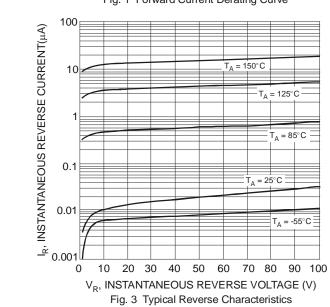
# **Electrical Characteristics** @TA = 25°C unless otherwise specified

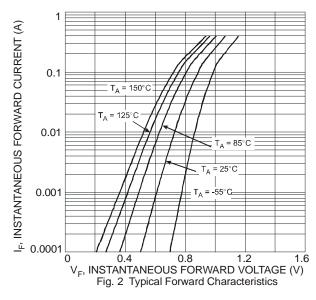
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)		75	_	V	$I_R = 100 \mu A$
	V <sub>F</sub>	0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage		_	0.855		$I_F = 10 \text{mA}$
r orward voltage		_	1.0		$I_F = 100 \text{mA}$
		_	1.25		I <sub>F</sub> = 150mA
		_	2.5	μΑ	$V_R = 75V$
Leakage Current (Note 5)	I <sub>R</sub>	_	50	μΑ	V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C
Leakage Current (Note 5)		_	30	μΑ	$V_R = 25V, T_J = 150^{\circ}C$
		_	25	nA	$V_R = 20V$
Total Capacitance	CT	_	4.0	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	•	4.0	ns	$I_F = I_R = 10 \text{mA},$
Treverse recovery fillic	۲rr		٦.0	113	$I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

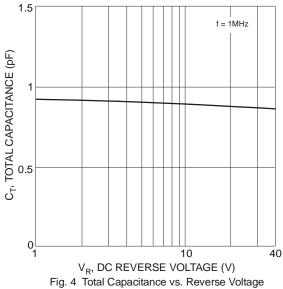
4. Part mounted on FR-4 PC board with minimum recommended pad layouts, which can be found on our website at http://www/diodes.com. 5. Short duration pulse test used to minimize self-heating. Notes:



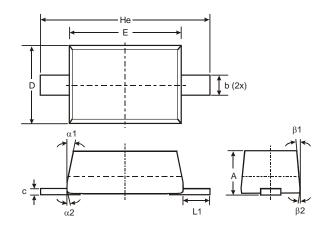








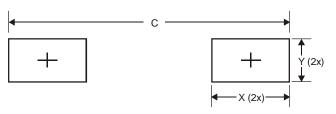
# **Package Outline Dimensions**



SOD323F						
Dim	Min	Max	Тур			
Α	0.60	0.75	-			
b	0.25	0.35	-			
С	0.05	0.26	-			
D	1.15	1.35	1.25			
Е	1.60	1.80	1.70			
He	2.30	2.70	2.50			
L1	0.30	0.50	0.40			
α1	-	-	7°			
α2	-	-	3°			
β1	_	_	7°			
β2	-	-	3°			
All Dimensions in mm						



### Suggested Pad Layout



Dimensions	Value (in mm)		
Х	0.710		
Υ	0.403		
С	2.700		

#### **IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2011, Diodes Incorporated

www.diodes.com

# 单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达迩科技(美台))